

## EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L3	1245	(thermosetting near resin) same (printed near circuit near board or "PCB" or "MLB" or "PWB")	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/05 09:19
L4	121	3 and (laser same (via or open\$3 or hole))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/05 09:20
L5	63	4 and @pd<"20030603"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/05 09:34
L6	17	5 and (solder near resist)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/05 09:35
L7	5	mok-jee-soo.in.	US-PGPUB; USPAT	OR	OFF	2006/03/05 09:54
L8	14	kang-jang-kyu.in.	US-PGPUB; USPAT	OR	OFF	2006/03/05 10:01
L9	1	nam-chang-hyun.in. and (solder\$3 near resist)	US-PGPUB; USPAT	OR	OFF	2006/03/05 10:02